

# Vishay General Semiconductor

# Low V<sub>F</sub> Surface Mount Transient Voltage Suppressors

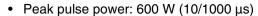


DO-214AA (SMB J-Bend)

PRIMARY CHARACTERISTICS				
V <sub>BR</sub>	13.2 - 14.8 V			
I <sub>PPM</sub> with 10 x 1000 μs	31 A			
I <sub>PPM</sub> with 1.4 x 6.5 μs	17.5 A			
V <sub>F</sub> at I <sub>F</sub> = 1.0 A	0.35 V			
I <sub>FSM</sub>	100 A			
T <sub>J</sub> max.	150 °C			

### **FEATURES**





· Ideal for automated placement

Low forward voltage

ROHS

 Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

• Solder dip 260 °C, 40 s

 Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

### **TYPICAL APPLICATIONS**

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs sensor units specifically for protecting 12 V supplied sensitive equipment against transient overvoltages.

### **MECHANICAL DATA**

Case: DO-214AA (SMBJ)

Molding compound meets UL 94 V-0 flammability

rating

Base P/N-E3 - RoHS compliant, commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Device marking code		L14			
Peak power pulse current with a 10/1000 μs waveform (Fig. 1) (1)(2)	I <sub>PPM</sub>	31	Α		
Peak pulse current with a 1.4/6.5 μs waveform (Fig. 2)	I <sub>PPM</sub>	17.5	Α		
Peak forward surge current 8.3 ms single half sine-wave (2)	I <sub>FSM</sub>	100	Α		
Power dissipation on infinite heatsink, T <sub>L</sub> = 50 °C	P <sub>D</sub>	5	W		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	- 65 to + 150	°C		

### Notes:

- (1) Non-repetitive current pulse, per Fig. 1 and derated above  $T_A = 25$  °C per Fig. 1
- (2) Mounted on P.C.B. with 5.0 x 5.0 mm copper pads attached to each terminal

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	TYP.	MAX.	UNIT
Breakdown voltage	at I <sub>Z</sub> = 1 mA	$V_{BR}$	13.2	ı	14.8	V
Max. clamping voltage with 10 x 1000 μs	at I <sub>PPM</sub> = 31 A	$V_{C}$	-	-	19.5	٧
Max. clamping voltage with 1.4 x 6.5 μs	at I <sub>PPM</sub> = 17.5 A	V <sub>C</sub>	-	-	15.8	V
Instantaneous forward voltage (1)	at $I_F = 1.0 \text{ A}$ $T_J = 25 ^{\circ}\text{C}$ $T_J = 125 ^{\circ}\text{C}$	$V_{F}$	-	0.45 0.35	0.5	V
Reverse leakage current (1)	at V <sub>WM</sub> = 12.0 V	I <sub>R</sub>	-	-	100	μΑ

#### Note:

(1) Measured on a 300 µs square pulse width

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER SYMBOL VALUE				
Typical thermal resistance, junction to lead	$R_{ hetaJL}$	20	°C/W	
Typical thermal resistance, junction to ambient (1)	$R_{ hetaJA}$	100	- C/VV	

### Note:

(1) Thermal resistance from junction to ambient - Mounted on the recommended P.C.B. pad layout

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
LVB14A-E3/52	0.096	52	750	7" diameter plastic tape and reel	
LVB14A-E3/5B	0.096	5B	3200	13" diameter plastic tape and reel	

## **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

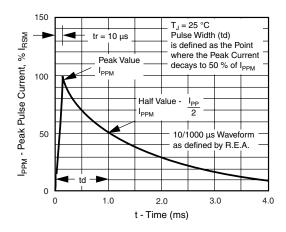


Figure 1. Pulse Waveform

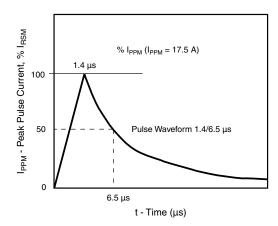


Figure 2. Pulse Waveform



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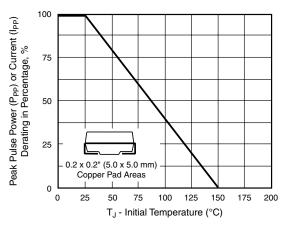


Figure 3. Pulse Poweror Current vs. Initial Junction Temperature

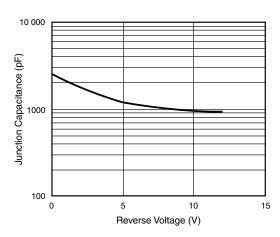


Figure 5. Typical Junction Capacitance

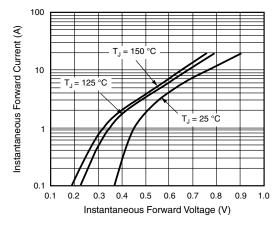
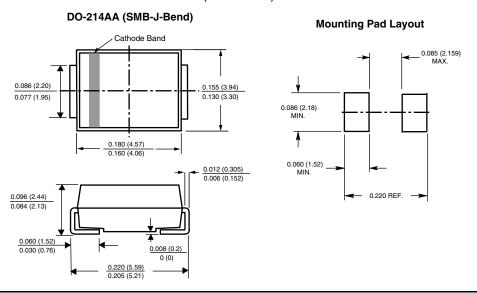


Figure 4. Typical Instantaneous Forward Characteristics

## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



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